



Description

JMT N-channel Enhancement Mode Power MOSFET

Features

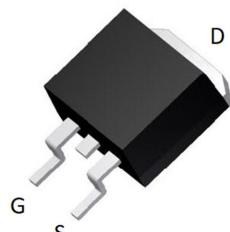
- 60V, 180A
- $R_{DS(ON)} < 3.8m\Omega$ @ $V_{GS} = 10V$
- Advanced Trench Technology
- Provide Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead free product is acquired

Application

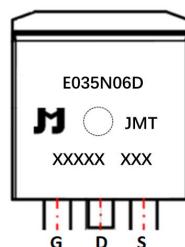
- Load Switch
- PWM Application
- Power management



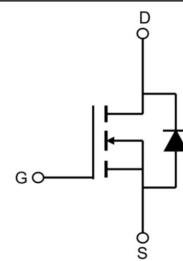
100% UIS TESTED!
100% ΔV_{ds} TESTED!



TO-263 top view



Marking and pin Assignment



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | OUTLINE | Device Package | Reel Size | Reel (PCS) | Per Carton (PCS) |
|----------------|-------------|---------|----------------|-----------|------------|------------------|
| JMTE035N06D | JMTE035N06D | TAPING | TO-263 | 13inch | 800 | 4000 |

Absolute Maximum Ratings ($T_c=25^\circ C$ unless otherwise specified)

| Symbol | Parameter | | Max. | Units |
|-----------------|---|---------------------|-------------|--------------|
| V_{DSS} | Drain-Source Voltage | | 60 | V |
| V_{GSS} | Gate-Source Voltage | | ± 20 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ C$ | 180 | A |
| | | $T_c = 100^\circ C$ | 117 | A |
| I_{DM} | Pulsed Drain Current ^{note1} | | 720 | A |
| EAS | Single Pulsed Avalanche Energy ^{note2} | | 324 | mJ |
| P_D | Power Dissipation | $T_c = 25^\circ C$ | 258 | W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 0.58 | $^\circ C/W$ |
| T_J, T_{STG} | Operating and Storage Temperature Range | | -55 to +175 | °C |

**Electrical Characteristics** ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristics | | | | | | |
| $V_{(\text{BR})\text{DSS}}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$ | 60 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=60\text{V}$, $V_{GS}=0\text{V}$, | - | - | 1.0 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}$, $V_{GS}= \pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$ | 2 | 3 | 4 | V |
| $R_{DS(\text{on})}$ | Static Drain-Source on-Resistance note3 | $V_{GS}=10\text{V}$, $I_D=30\text{A}$ | - | 2.9 | 3.8 | $\text{m}\Omega$ |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$ | - | 7660 | - | pF |
| C_{oss} | Output Capacitance | | - | 642 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 620 | - | pF |
| Q_g | Total Gate Charge | $V_{DS}=30\text{V}$, $I_D=30\text{A}$, $V_{GS}=10\text{V}$ | - | 138 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 21 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 33 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD}=30\text{V}$, $I_D=30\text{A}$, $R_L=1\Omega$, $R_{\text{GEN}}=3\Omega$, $V_{GS}=10\text{V}$ | - | 14 | - | ns |
| t_r | Turn-on Rise Time | | - | 10 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 65 | - | ns |
| t_f | Turn-off Fall Time | | - | 27 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_S | Maximum Continuous Drain to Source Diode Forward Current | - | - | 180 | - | A |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | 720 | - | A |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_S=30\text{A}$ | - | - | 1.2 | V |
| t_{rr} | Body Diode Reverse Recovery Time | $T_J=25^\circ\text{C}$, $I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | - | 52 | - | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | | - | 75 | - | nC |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition : $T_J=25^\circ\text{C}$, $V_{DD}=40\text{V}$, $V_G=10\text{V}$, $L=0.5\text{mH}$, $R_g=25\Omega$, $I_{AS}=36\text{A}$ 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

Typical Performance Characteristics

Figure 1: Output Characteristics

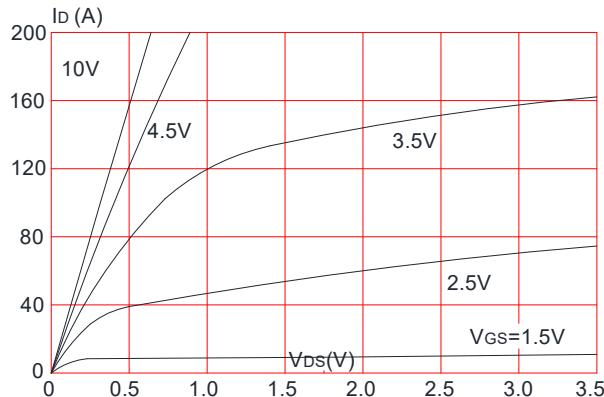


Figure 3: On-resistance vs. Drain Current

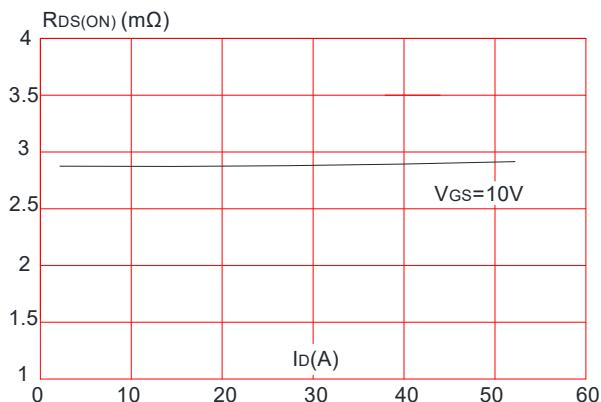


Figure 5: Gate Charge Characteristics

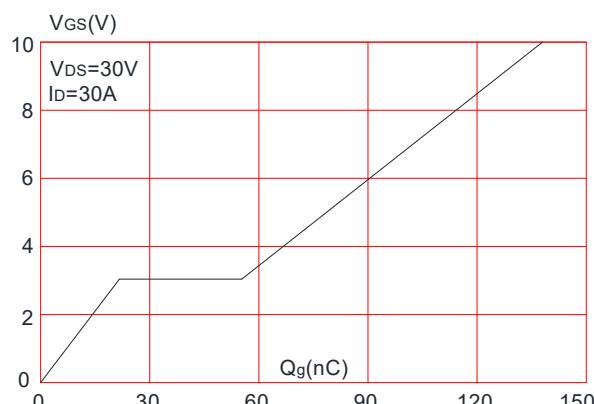


Figure 2: Typical Transfer Characteristics

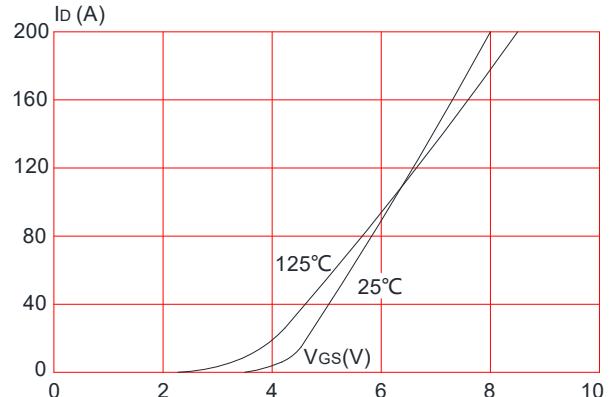


Figure 4: Body Diode Characteristics

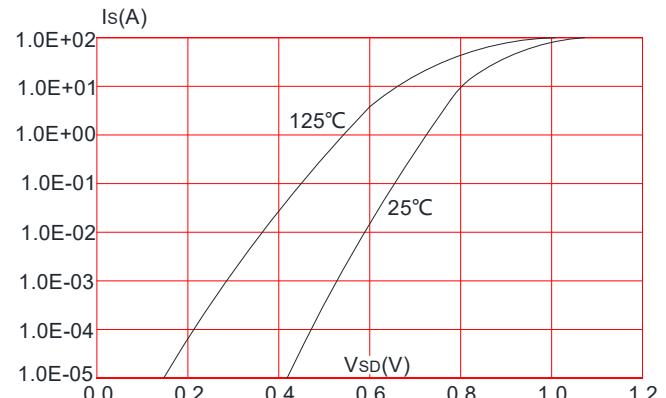


Figure 6: Capacitance Characteristics

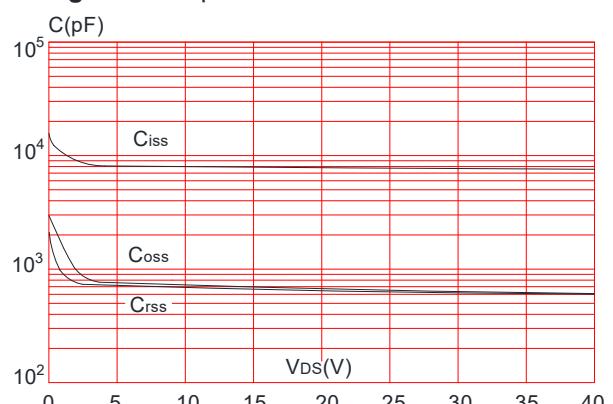


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

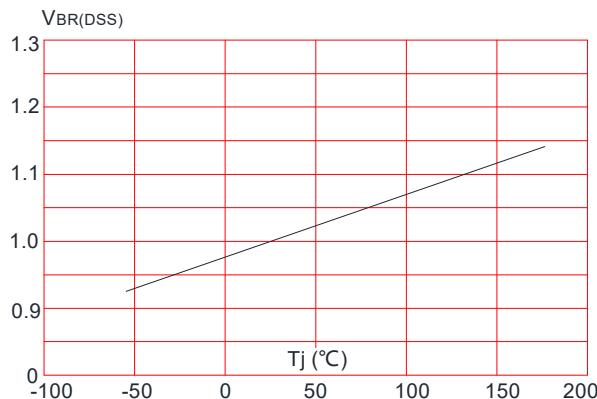


Figure 9: Maximum Safe Operating Area

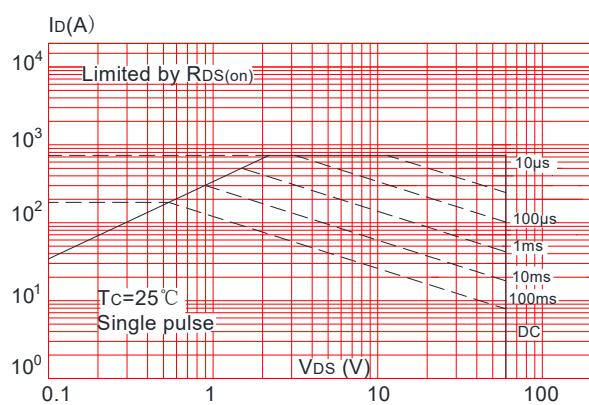


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

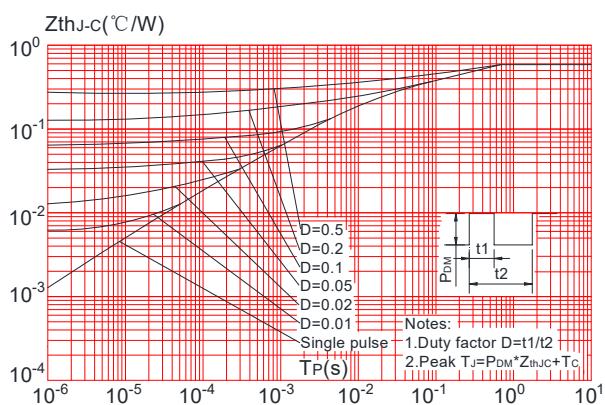


Figure 8: Normalized on Resistance vs. Junction Temperature

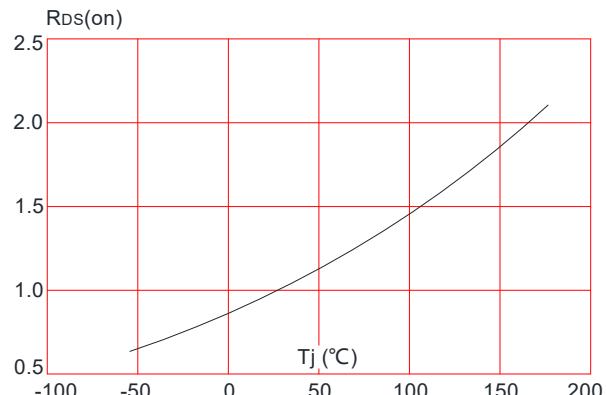
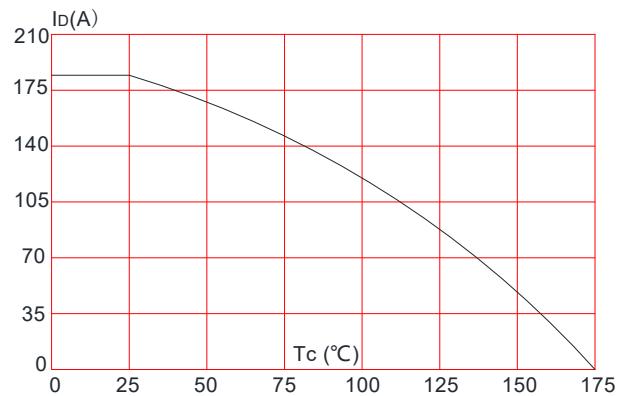


Figure 10: Maximum Continuous Drain Current vs. Case Temperature



Test Circuit

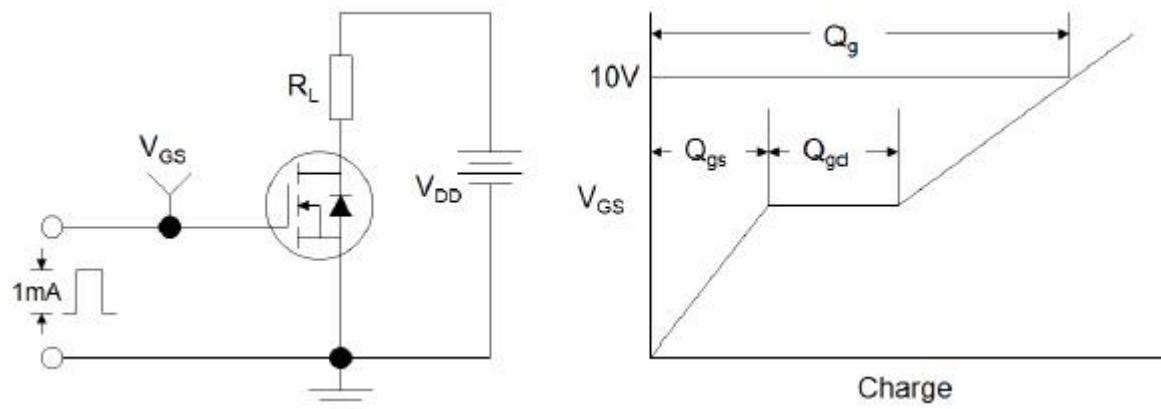


Figure1:Gate Charge Test Circuit & Waveform



Figure 2: Resistive Switching Test Circuit & Waveforms

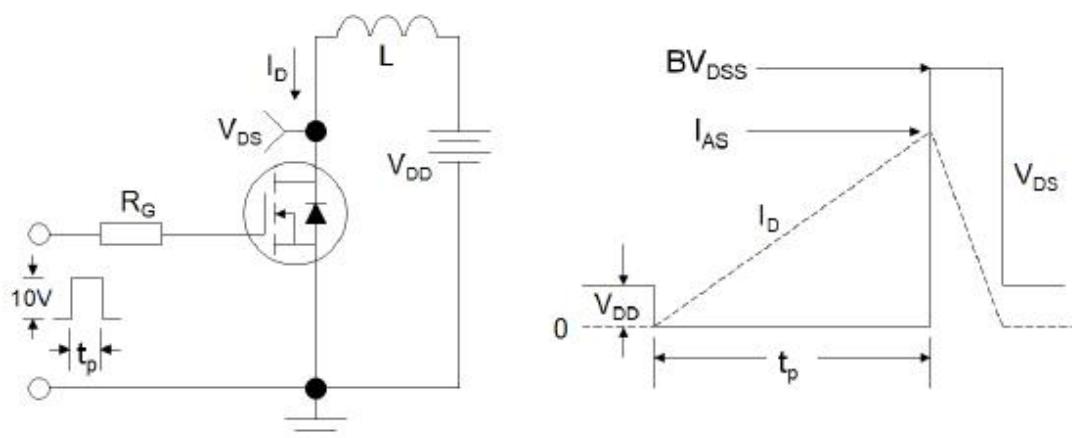
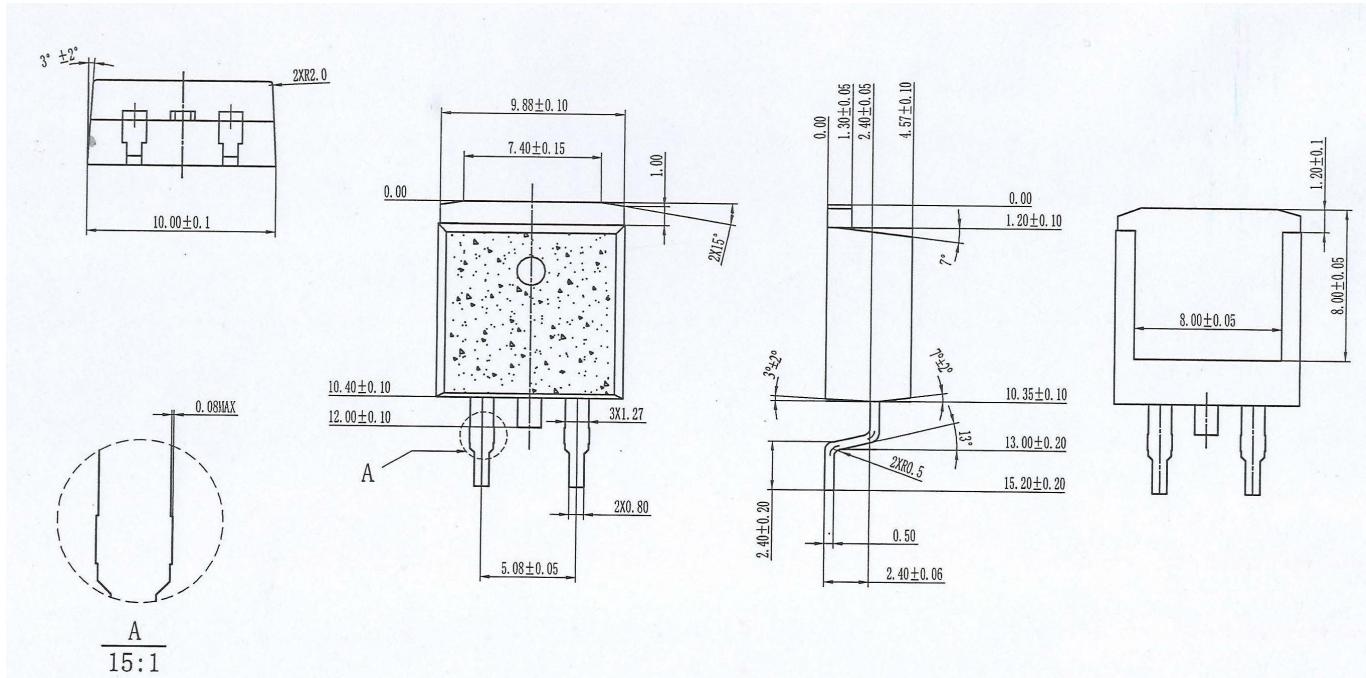


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms



Package Mechanical Data- TO-263



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